

Fig. 1

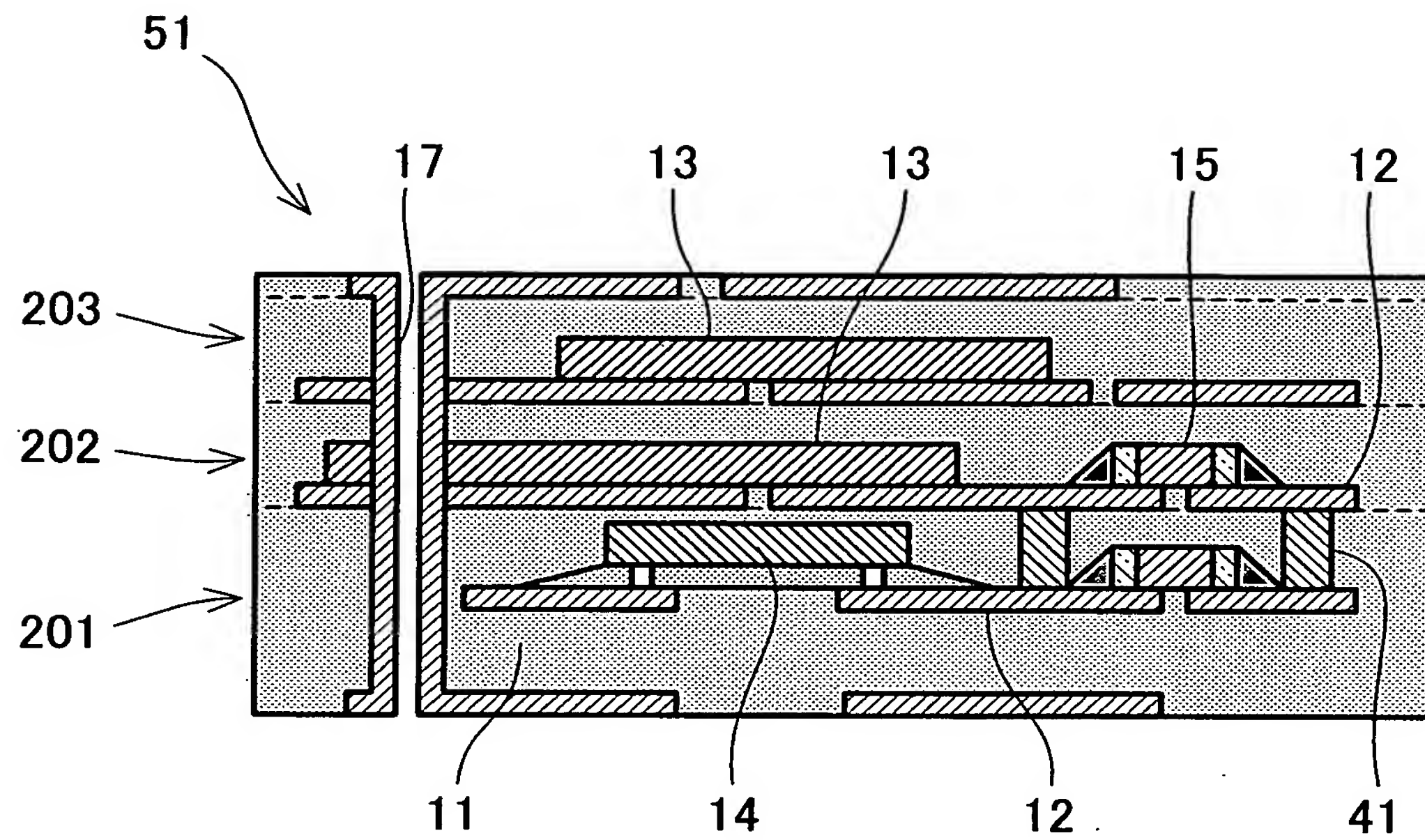


Fig. 2

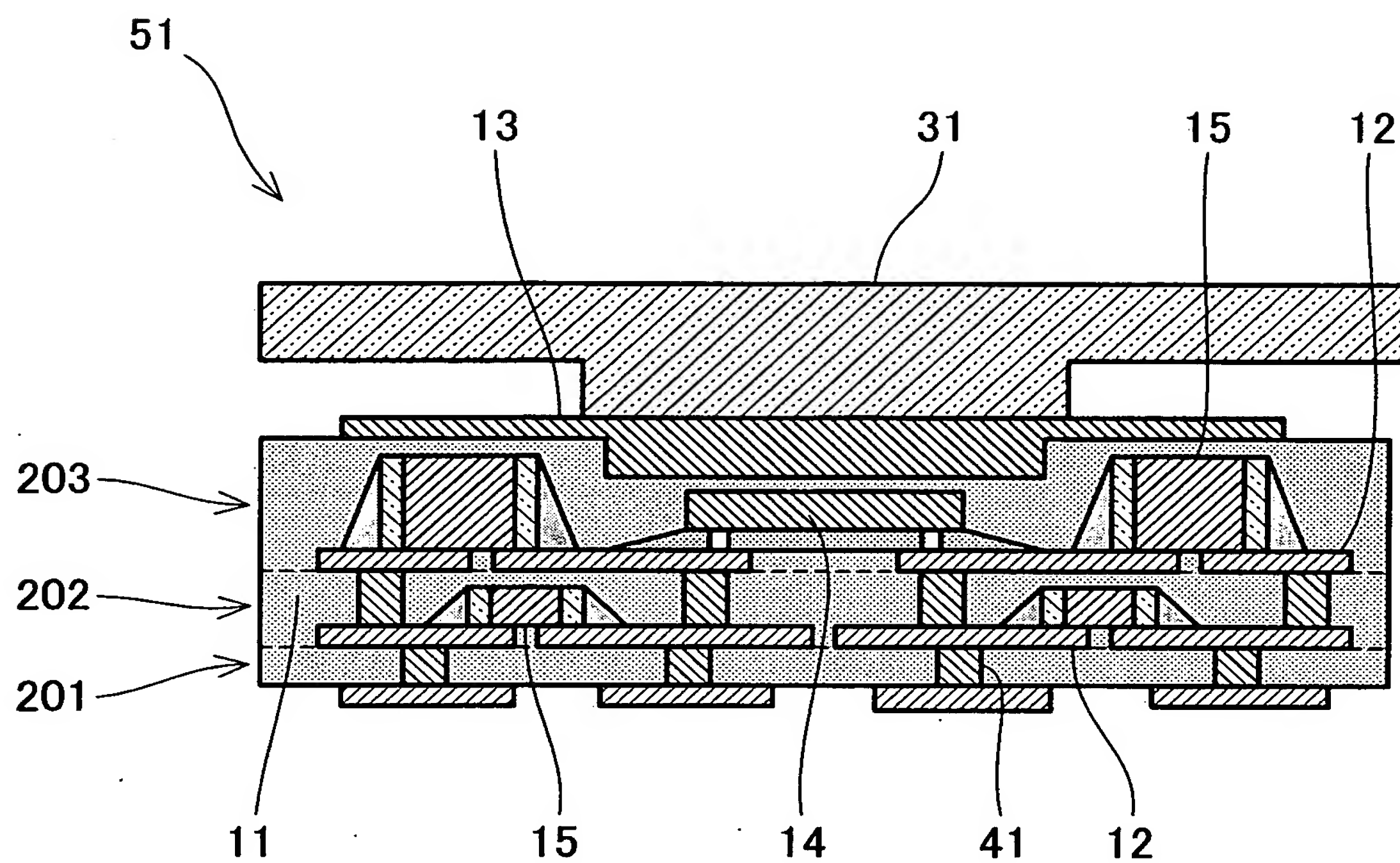


Fig. 3

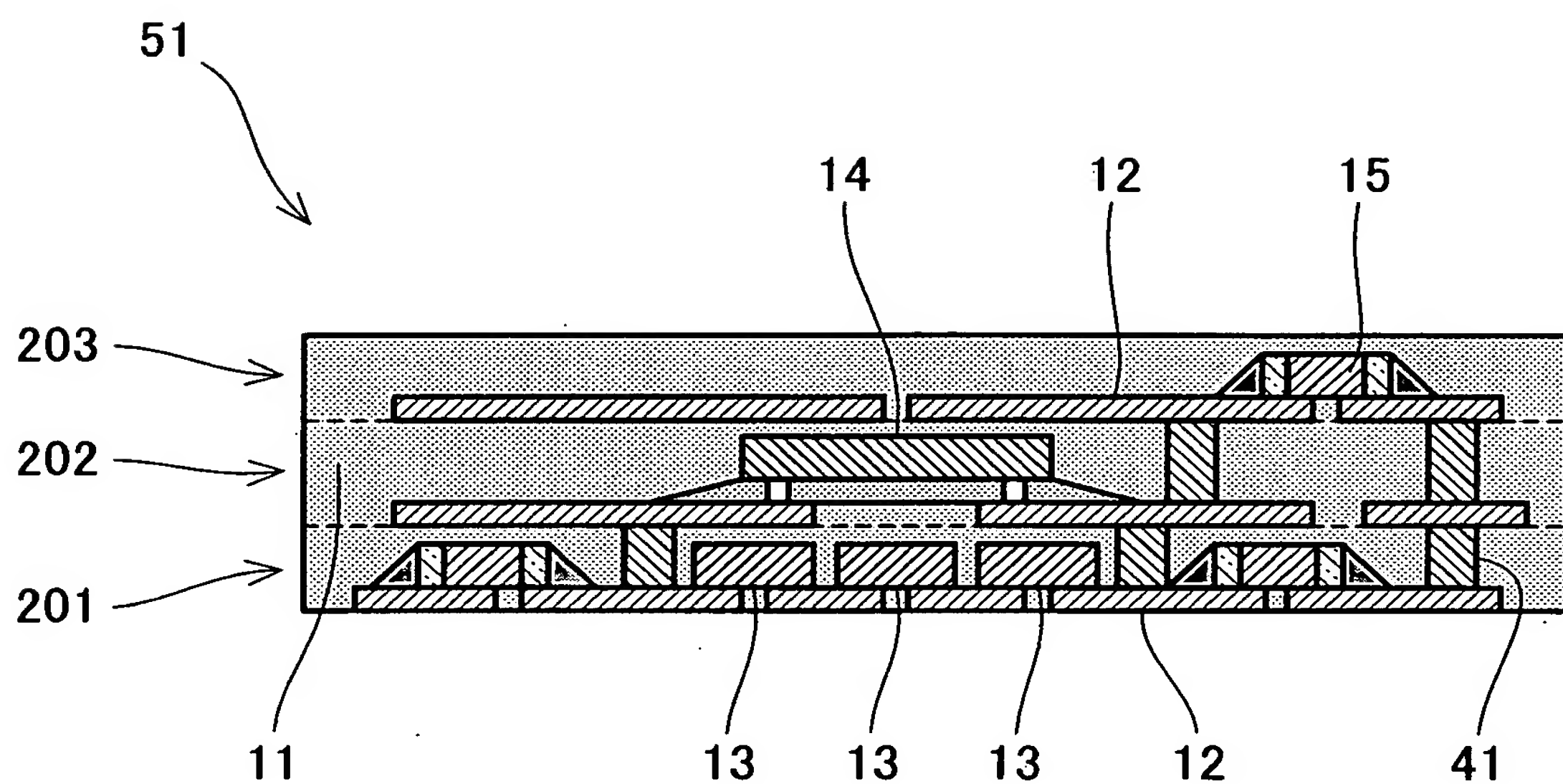


Fig. 4

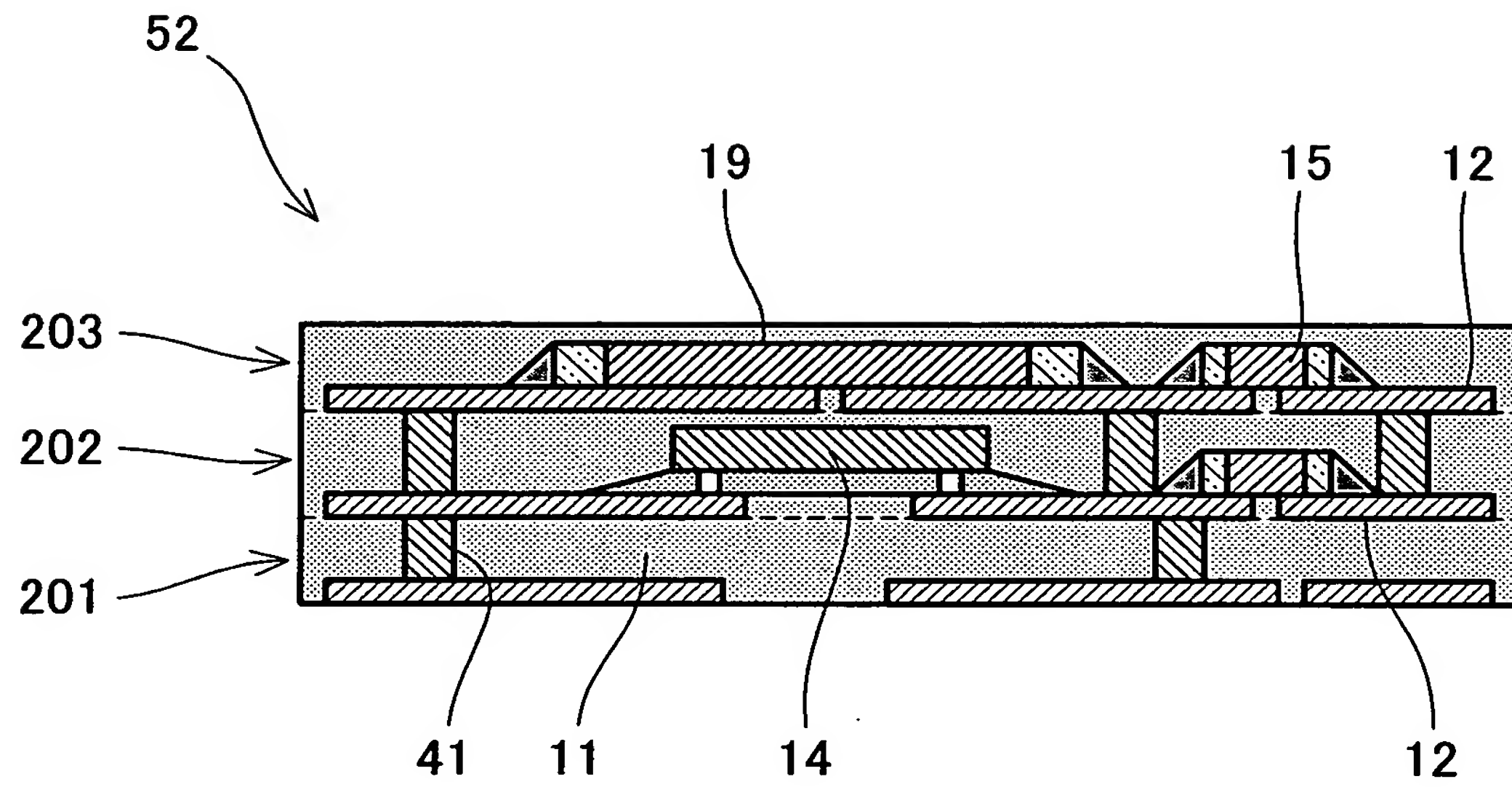


Fig. 5

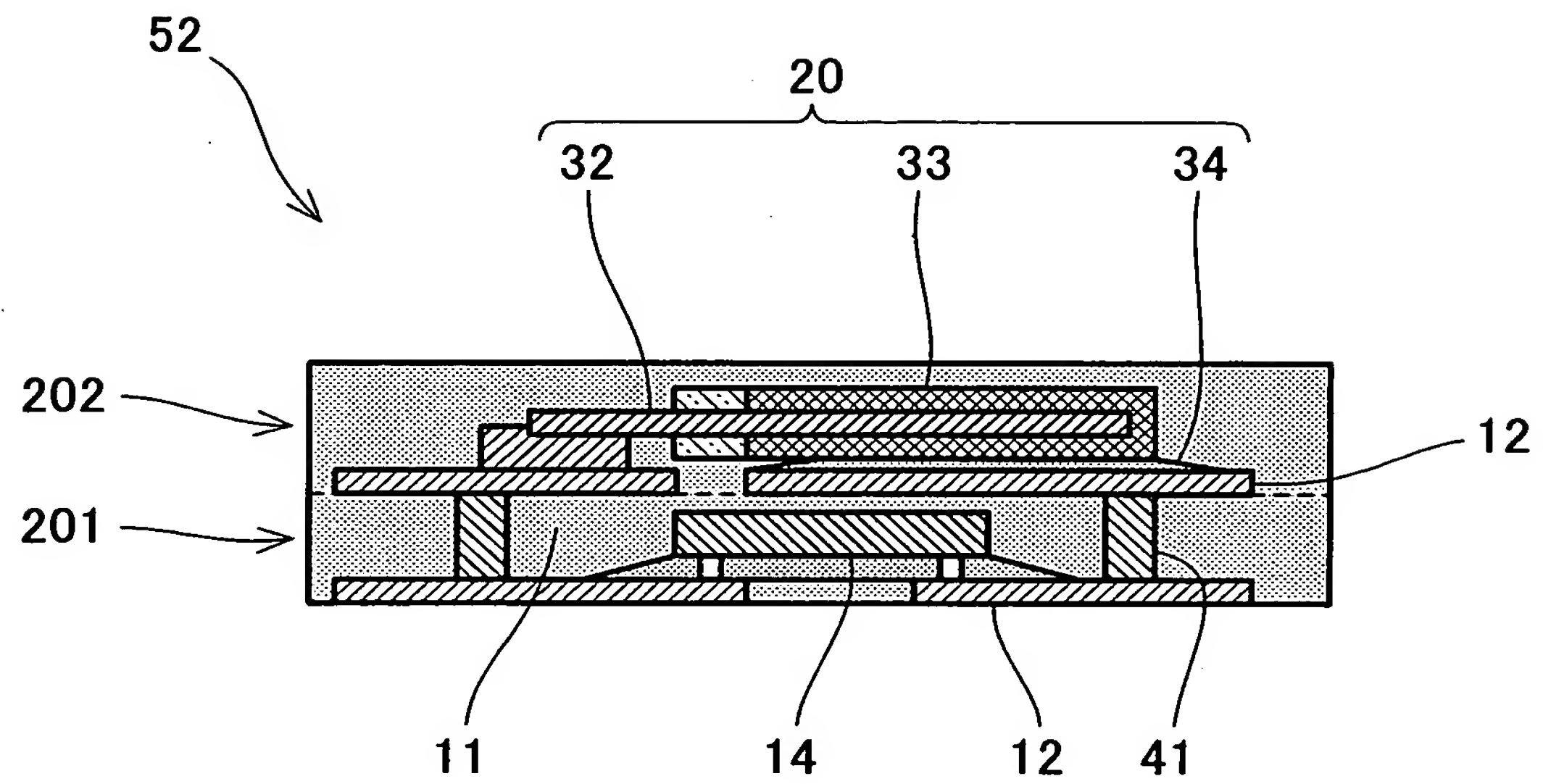


Fig. 6

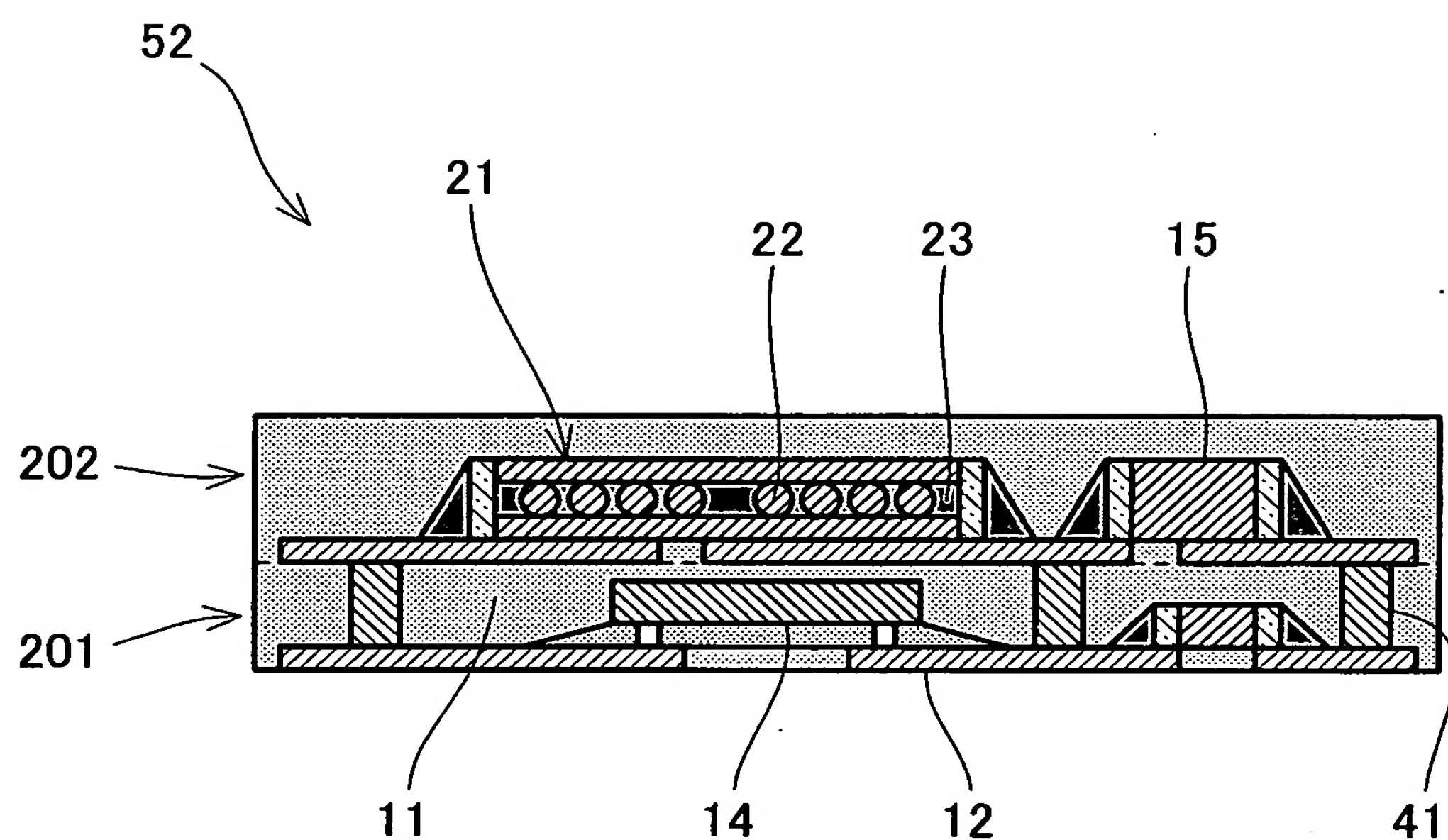


Fig. 7

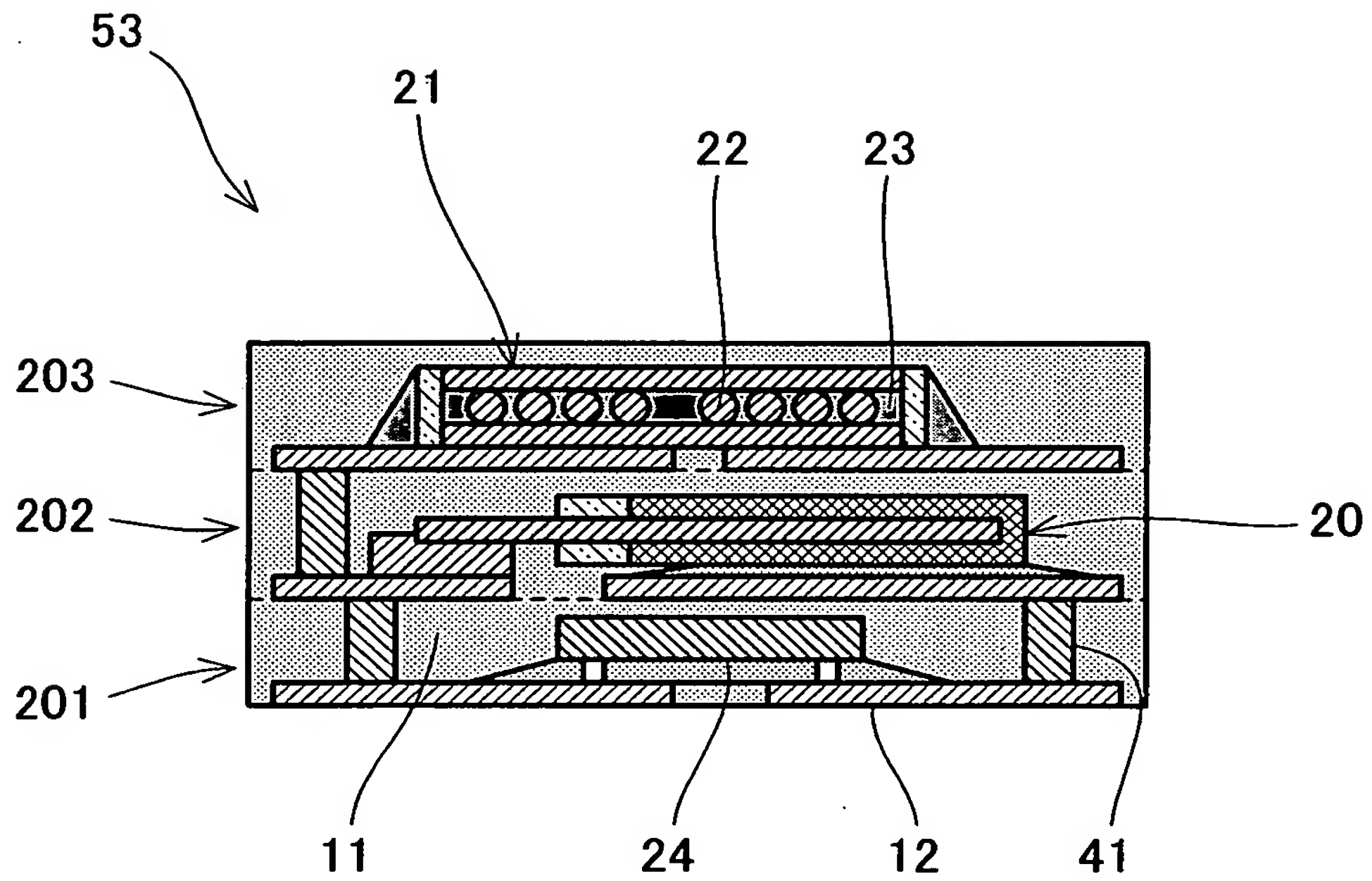


Fig. 8

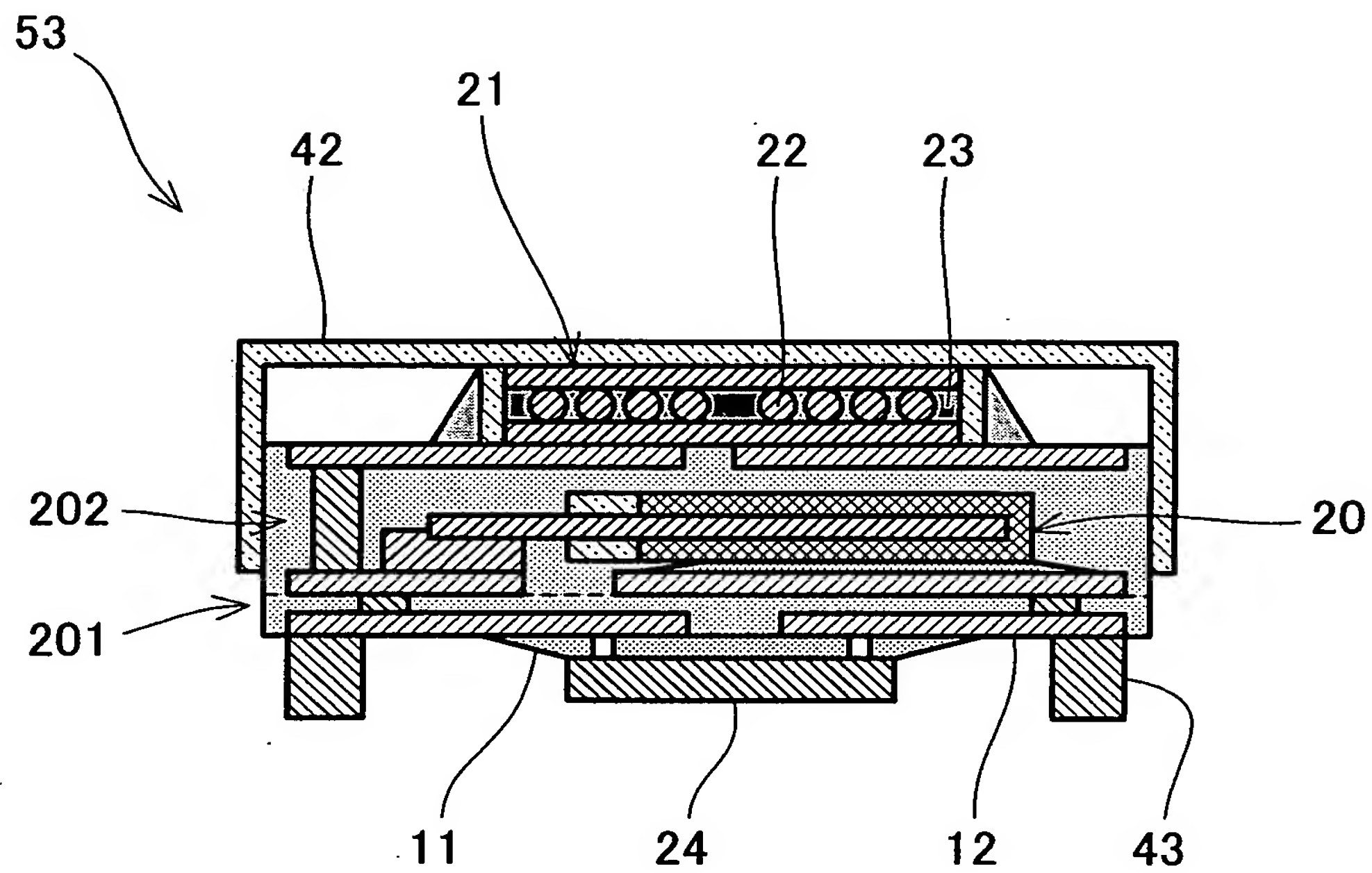


Fig. 9

20000000

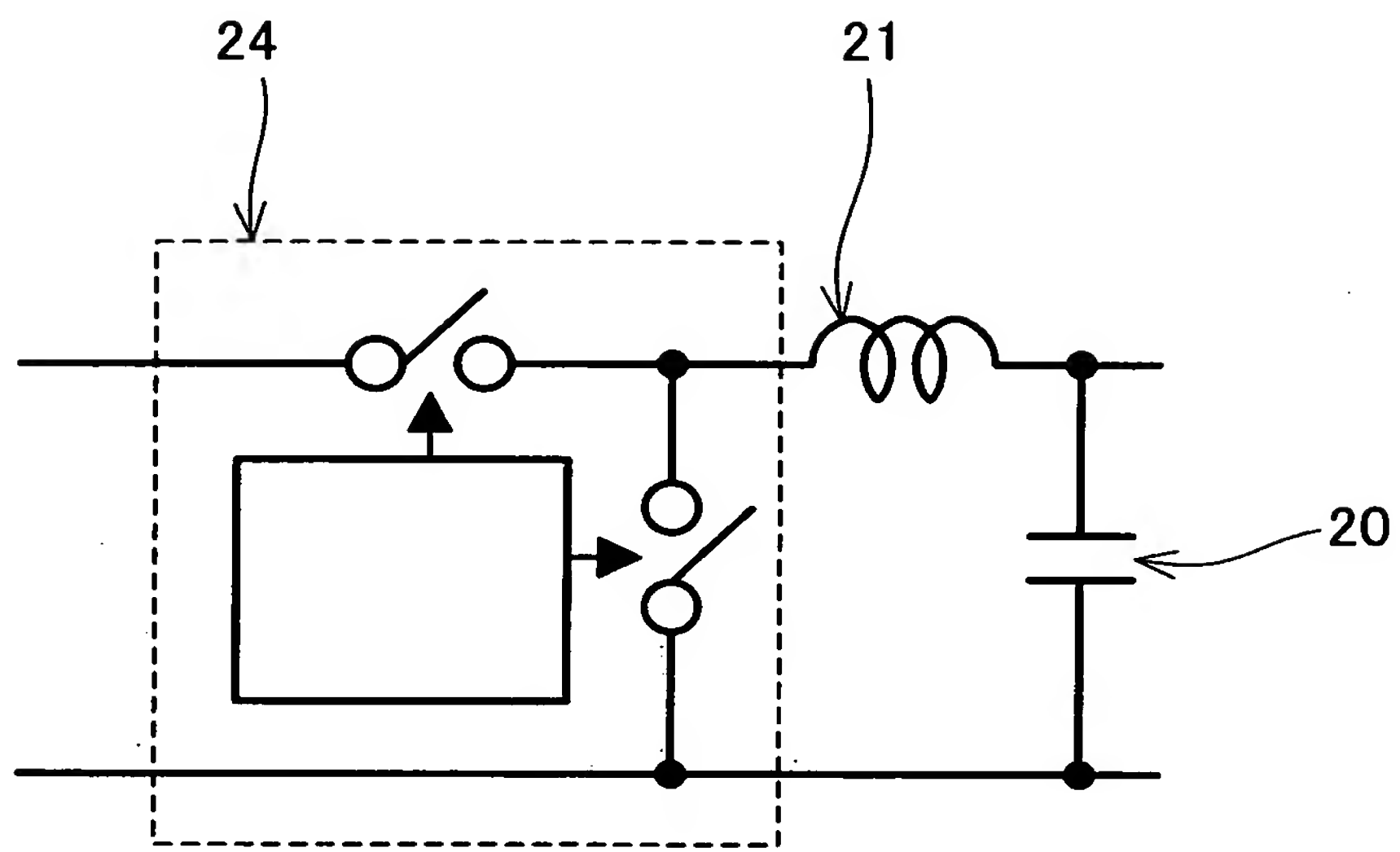


Fig. 10

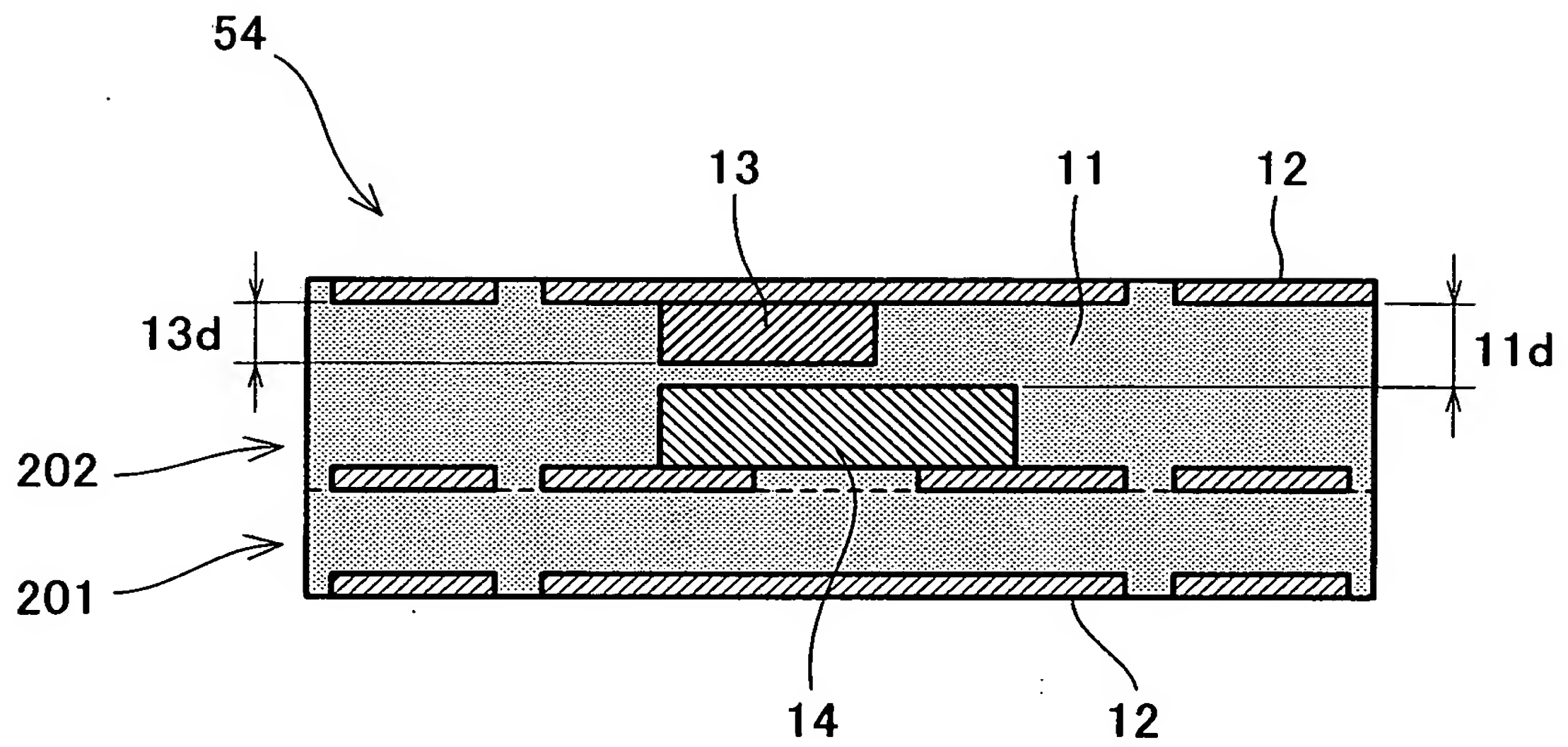
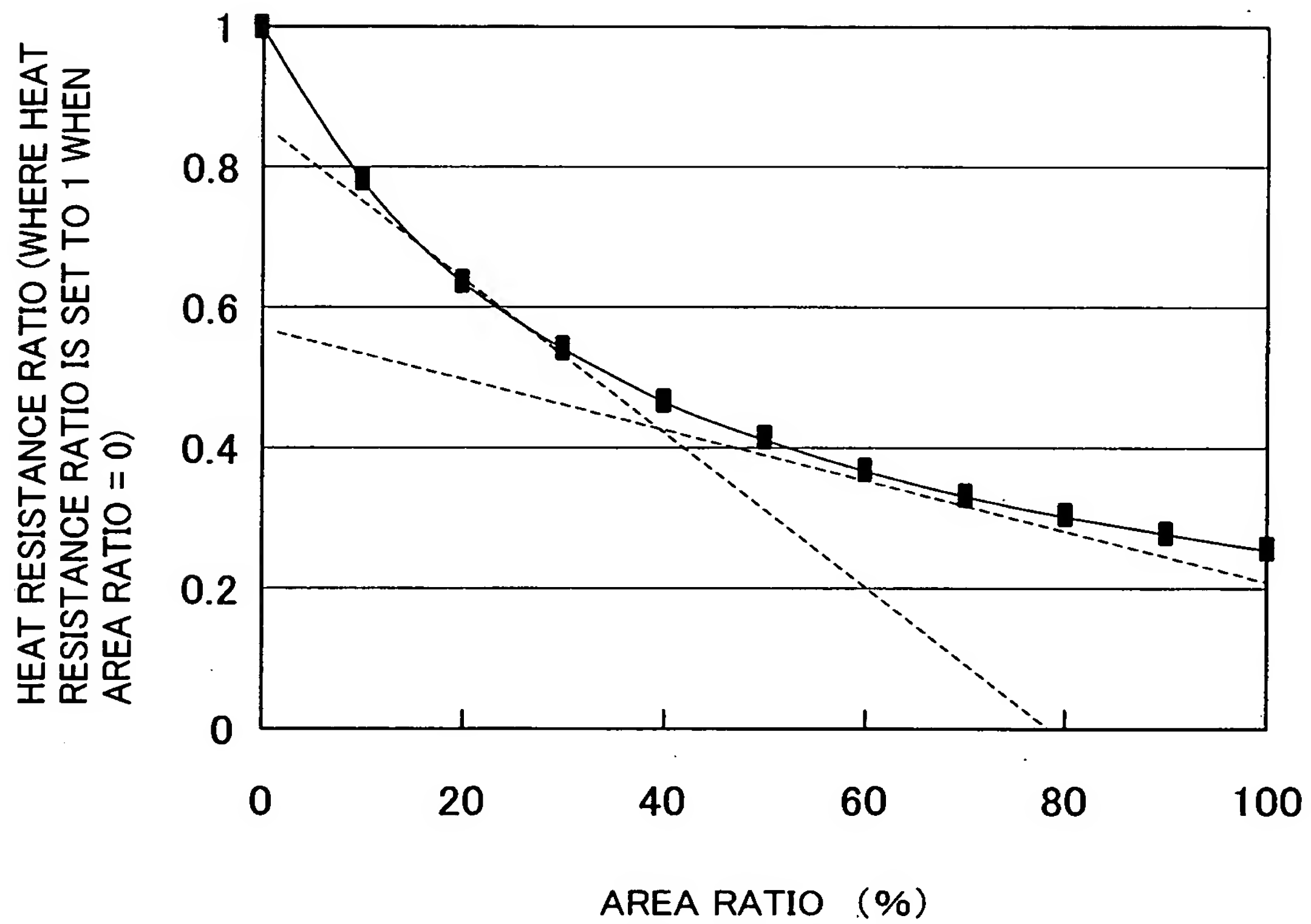


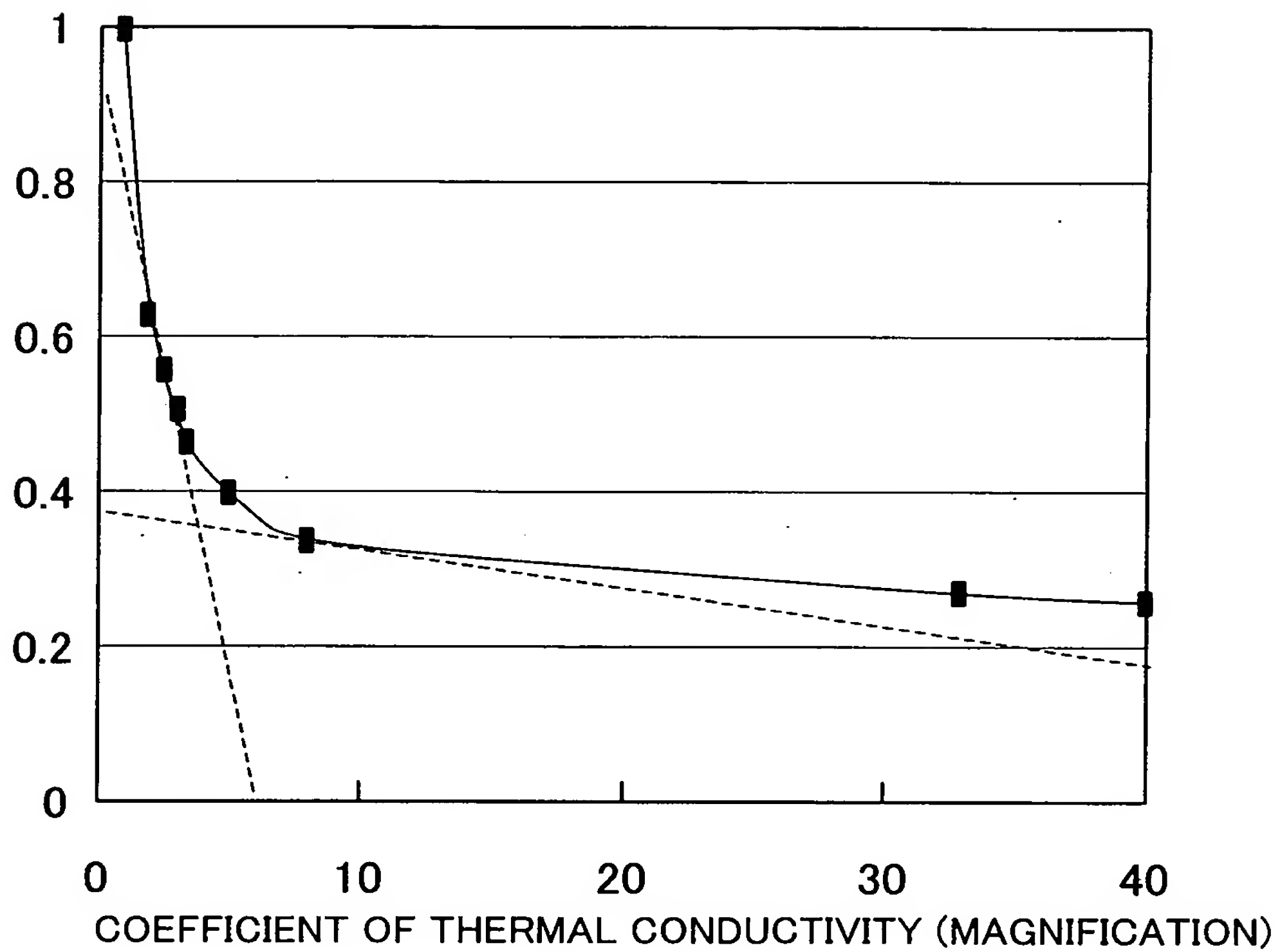
Fig. 11



(THE AREA OF THE MEMBER HAVING HIGH THERMAL CONDUCTIVITY / THE AREA OF THE CIRCUIT ELEMENT) $\times 100$

Fig. 12

HEAT RESISTANCE RATIO (WHERE HEAT
RESISTANCE RATIO IS SET TO 1 WHEN
THERMAL CONDUCTIVITY = 1)



(THE THERMAL CONDUCTIVITY OF THE MEMBER HAVING HIGH
THERMAL CONDUCTIVITY / THE THERMAL CONDUCTIVITY OF
THE ELECTRICALLY INSULATING MATERIAL))

Fig. 13

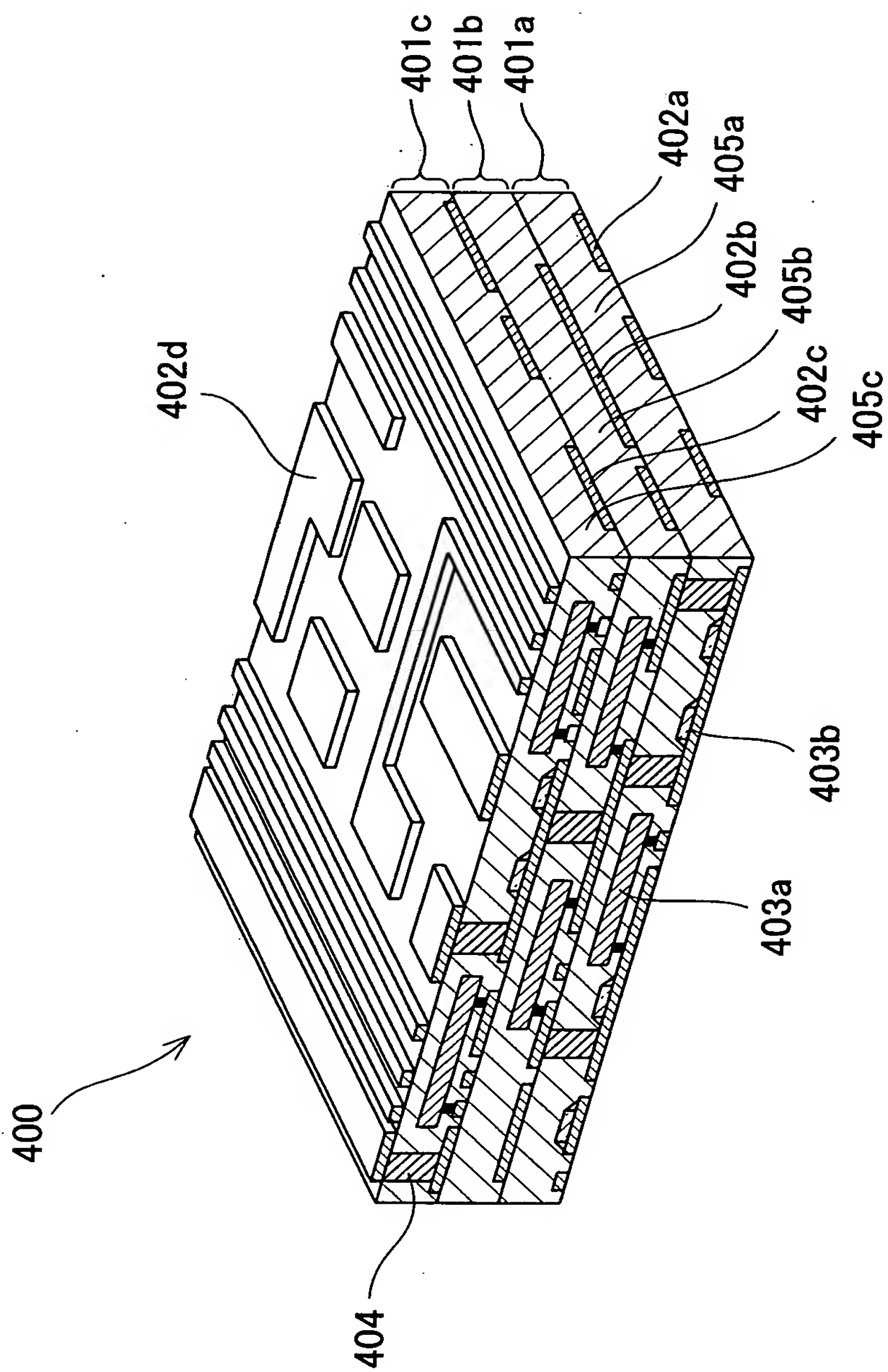


Fig. 14

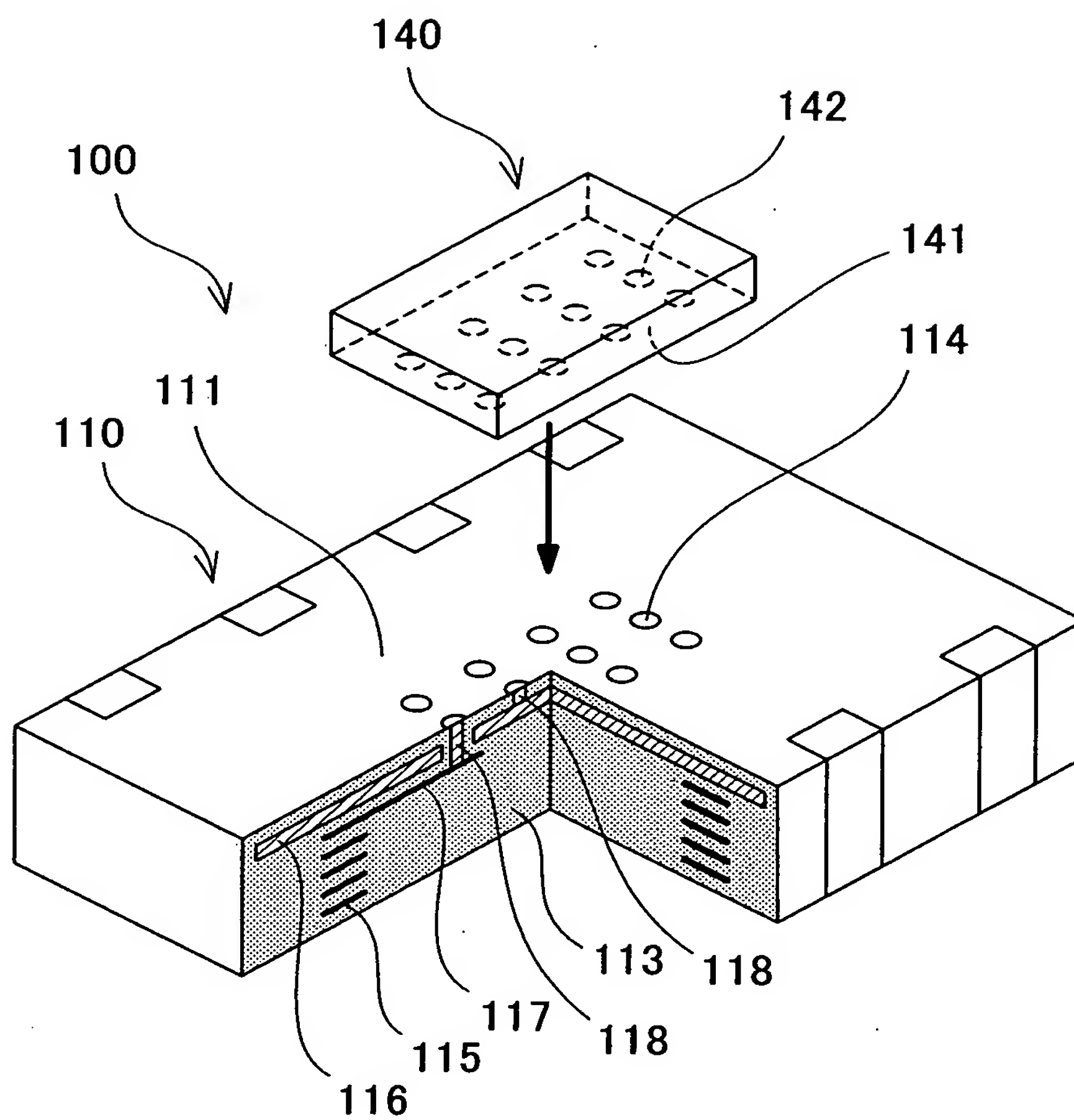


Fig. 15